

United States Patent and Trademark Office

UNITED STATES DEPARTMENT OF COMMERC! United States Patent and Trademark Office Address: COMMISSIONER FOR PATENTS P.O. Box 1450 Alexandria, Virginia 22313-1450 www.uspto.gov

ATTORNEY DOCKET NO. CONFIRMATION NO. FIRST NAMED INVENTOR APPLICATION NO. FILING DATE 10/517,782 12/10/2004 Kazuyuki Hasegawa MATS:050 8603 **EXAMINER** 37013 7590 08/22/2006 MACCHIAROLO, PETER J ROSSI, KIMMS & McDOWELL LLP. P.O. BOX 826 PAPER NUMBER ART UNIT ASHBURN, VA 20146-0826 2879

DATE MAILED: 08/22/2006

Please find below and/or attached an Office communication concerning this application or proceeding.

| | Application No. | Applicant(s) | |
|--|--|--|-------------|
| Office Action Summary | 10/517,782 HASEGAWA ET AL. | | |
| | Examiner | Art Unit | |
| | Peter J. Macchiarolo | 2879 | |
| The MAILING DATE of this communication app Period for Reply | | · | |
| A SHORTENED STATUTORY PERIOD FOR REPL' WHICHEVER IS LONGER, FROM THE MAILING D. Extensions of time may be available under the provisions of 37 CFR 1.1 after SIX (6) MONTHS from the mailing date of this communication. If NO period for reply is specified above, the maximum statutory period of Failure to reply within the set or extended period for reply will, by statute Any reply received by the Office later than three months after the mailing earned patent term adjustment. See 37 CFR 1.704(b). | ATE OF THIS COMMUNION (36(a). In no event, however, may a rewill apply and will expire SIX (6) MON, cause the application to become AB | CATION. Poply be timely filed THS from the mailing date of this communic ANDONED (35 U.S.C. § 133). | |
| Status | | | |
| 1) ☐ Responsive to communication(s) filed on 12 Ju 2a) ☐ This action is FINAL. 2b) ☐ This 3) ☐ Since this application is in condition for alloware closed in accordance with the practice under E | action is non-final. nce except for formal matt | | ts is |
| Disposition of Claims | | | |
| 4) Claim(s) 1-10 is/are pending in the application. 4a) Of the above claim(s) is/are withdray 5) Claim(s) is/are allowed. 6) Claim(s) 1-10 is/are rejected. 7) Claim(s) is/are objected to. 8) Claim(s) are subject to restriction and/o | wn from consideration. | | |
| Application Papers | | | |
| 9) ☐ The specification is objected to by the Examine 10) ☑ The drawing(s) filed on 10 December 2004 is/a Applicant may not request that any objection to the Replacement drawing sheet(s) including the correct 11) ☐ The oath or declaration is objected to by the Ex | re: a)⊠ accepted or b)☐ drawing(s) be held in abeyar ion is required if the drawing | ce. See 37 CFR 1.85(a). s) is objected to. See 37 CFR 1.1. | |
| Priority under 35 U.S.C. § 119 | | | |
| a) Acknowledgment is made of a claim for foreign a) All b) Some * c) None of: 1. Certified copies of the priority document 2. Certified copies of the priority document 3. Copies of the certified copies of the priority document application from the International Bureau * See the attached detailed Office action for a list | s have been received. s have been received in A rity documents have been u (PCT Rule 17.2(a)). | pplication No received in this National Stage | e |
| Attachment(s) 1) Notice of References Cited (PTO-892) 2) Notice of Draftsperson's Patent Drawing Review (PTO-948) 3) Information Disclosure Statement(s) (PTO-1449 or PTO/SB/08) Paper No(s)/Mail Date 12/10/2004 | Paper No(s | ummary (PTO-413))/Mail Date nformal Patent Application (PTO-152) | |

Art Unit: 2879

DETAILED ACTION

Priority

Receipt is acknowledged of papers submitted under 35 U.S.C. 119(a)-(d), which papers have been placed of record in the file.

Information Disclosure Statement

The information disclosure statement (IDS) submitted on 12/10/2004 is in compliance with the provisions of 37 CFR 1.97. Accordingly, the information disclosure statement is being considered by the examiner.

Double Patenting

The nonstatutory double patenting rejection is based on a judicially created doctrine grounded in public policy (a policy reflected in the statute) so as to prevent the unjustified or improper timewise extension of the "right to exclude" granted by a patent and to prevent possible harassment by multiple assignees. A nonstatutory obviousness-type double patenting rejection is appropriate where the conflicting claims are not identical, but at least one examined application claim is not patentably distinct from the reference claim(s) because the examined application claim is either anticipated by, or would have been obvious over, the reference claim(s). See, e.g., *In re Berg*, 140 F.3d 1428, 46 USPQ2d 1226 (Fed. Cir. 1998); *In re Goodman*, 11 F.3d 1046, 29 USPQ2d 2010 (Fed. Cir. 1993); *In re Longi*, 759 F.2d 887, 225 USPQ 645 (Fed. Cir. 1985); *In re Van Ornum*, 686 F.2d 937, 214 USPQ 761 (CCPA 1982); *In re*

į

Art Unit: 2879

Vogel, 422 F.2d 438, 164 USPQ 619 (CCPA 1970); and *In re Thorington*, 418 F.2d 528, 163 USPQ 644 (CCPA 1969).

A timely filed terminal disclaimer in compliance with 37 CFR 1.321(c) or 1.321(d) may be used to overcome an actual or provisional rejection based on a nonstatutory double patenting ground provided the conflicting application or patent either is shown to be commonly owned with this application, or claims an invention made as a result of activities undertaken within the scope of a joint research agreement.

Effective January 1, 1994, a registered attorney or agent of record may sign a terminal disclaimer. A terminal disclaimer signed by the assignee must fully comply with 37 CFR 3.73(b).

Claims 1, 4, 7, and 8 are provisionally rejected on the ground of nonstatutory obviousness-type double patenting as being unpatentable over claims 1 of copending Application No. 10/535951 to Hasegawa et al (US PGPUB 20060055324; "Hasegawa").

Regarding claims 1 and 8, Hasegawa claims a PDP with a protective layer formed on a dielectric layer, the protective layer includes at least one of carbon and silicon. Hasegawa does not expressly claim the protective layer has both carbon and silicon, but does infer this limitation with the claim language, "at least one of." One of ordinary skill in the art would be motivated to use both carbon and silicon to allow for a more durable protection layer.

Regarding claims 4 and 7, only obvious methods are claimed and the above rejection to claim 1 likewise applies to claims 4 and 7.

;

Art Unit: 2879

Claims 1, 4, 7, and 8 are provisionally rejected on the ground of nonstatutory obviousness-type double patenting as being unpatentable over claims 1 of copending Application No. 10/535823 to Hasegawa et al (US PGPUB 20050285532; "'532").

Regarding claims 1 and 8, '532 claims a PDP with a protective layer formed on a dielectric layer, the protective layer includes MgO, MgC, and Si, anticipating Applicant's instant claims, in which the protection layer comprises carbon and silicon.

Regarding claims 4 and 7, only obvious methods are claimed and the above '532 rejection to claim 1 likewise applies to claims 4 and 7.

These are <u>provisional</u> obviousness-type double patenting rejections.

Claim Rejections - 35 USC § 102

The following is a quotation of the appropriate paragraphs of 35 U.S.C. 102 that form the basis for the rejections under this section made in this Office action:

A person shall be entitled to a patent unless -

- (b) the invention was patented or described in a printed publication in this or a foreign country or in public use or on sale in this country, more than one year prior to the date of application for patent in the United States.
- (e) the invention was described in (1) an application for patent, published under section 122(b), by another filed in the United States before the invention by the applicant for patent or (2) a patent granted on an application for patent by another filed in the United States before the invention by the applicant for patent, except that an international application filed under the treaty defined in section 351(a) shall have the effects for purposes of this subsection of an application filed in the United States only if the international application designated the United States and was published under Article 21(2) of such treaty in the English language.

Claims 1, 4, 7, and 8 are rejected under 35 U.S.C. 102(e) as being anticipated by Inoue et al (USPN 20040027072; "Inoue").

Applicant cannot rely upon the foreign priority papers to overcome this rejection because a translation of said papers has not been made of record in accordance with 37 CFR 1.55. See MPEP § 201.15.

Art Unit: 2879

Regarding claim 1, Inoue shows in figure 3, a plasma display panel in which a dielectric layer (4) is formed so that the dielectric layer (4) covers a scanning electrode (31) and a sustain electrode (31) formed on a substrate (1), and in which a protective layer (12) is formed on the dielectric layer (4), wherein the protective layer (12) includes carbon and silicon (see for example the ABSTRACT, protective layer is SiC).

Regarding claim 4, Inoue discloses in figure 3 and in paragraphs 75-96 a method of manufacturing a plasma display panel in which a dielectric layer (4) is formed so that the dielectric layer (4) covers a scanning electrode (31) and a sustain electrode (31) formed on a substrate (1), and in which a protective layer (12) is formed on the dielectric layer (4), wherein a process for forming the protective layer (12) is a process for forming a film using a material (SiC) for a protective layer, including carbon and silicon.

Regarding claim 7, Inoue discloses in figure 3 and in paragraphs 75-96 a method of manufacturing a plasma display panel in which a dielectric layer (4) is formed so that the dielectric layer (4) covers a scanning electrode (31) and a sustain electrode (31) formed on a substrate (1), and in which a protective layer (12) is formed on the dielectric layer (4), wherein carbon and silicon are added in the protective layer (12).

The Examiner notes that the claim limitation "added in the protective layer after the protective layer is formed on the dielectric layer" is drawn to a process of manufacturing which is incidental to the claimed apparatus. It is well established that a claimed apparatus cannot be distinguished over the prior art by a process limitation. Consequently, absent a showing of an

:

Art Unit: 2879

unobvious difference between the claimed product and the prior art, the subject product-by-process claim limitation has been considered, but not patentably distinct over Inoue (see MPEP 2113).

Regarding claim 8, Inoue discloses in figure 3 and in paragraphs 75-96 a material for a protective layer of a plasma display panel in which a dielectric layer (4) is formed so that the dielectric layer (4) covers a scanning electrode (31) and a sustain electrode (31) formed on a substrate (1), and in which a protective layer (12) is formed on the dielectric layer (4), wherein the material for a protective layer includes carbon and silicon (specifically, SiC).

Claims 1, 3, 4, 7, and 8 are rejected under 35 U.S.C. 102(b) as being anticipated by Applicant cited Hidaka et al (JP PUB 2001110321; "Hidaka").

Regarding claim 1, Hidaka shows in figure 4, a plasma display panel in which a dielectric layer (17) is formed so that the dielectric layer (17) covers a scanning electrode (X) and a sustain electrode (Y) formed on a substrate (11), and in which a protective layer (18) is formed on the dielectric layer (17), wherein the protective layer (18) includes carbon and silicon (see for example paragraph 37, protective layer is [(C₆ H₁₃COO)₄ Si].

Regarding claim 3, Hidaka discloses in paragraph 37 that the number of carbon atoms is greater than that of silicon.

Page 7

Art Unit: 2879

Regarding claim 4, Hidaka discloses in figure 4 and in paragraph 37 a method of manufacturing a plasma display panel in which a dielectric layer (17) is formed so that the dielectric layer (17) covers a scanning electrode (X) and a sustain electrode (Y) formed on a substrate (11), and in which a protective layer (18) is formed on the dielectric layer (17), wherein a process for forming the protective layer (18) is a process for forming a film using a material [(C₆ H₁₃COO)₄ Si] for a protective layer, including carbon and silicon.

Regarding claim 7, Hidaka discloses in figure 3 and in paragraphs 75-96 a method of manufacturing a plasma display panel in which a dielectric layer (4) is formed so that the dielectric layer (4) covers a scanning electrode (31) and a sustain electrode (31) formed on a substrate (1), and in which a protective layer (12) is formed on the dielectric layer (4), wherein carbon and silicon are added in the protective layer (12).

The Examiner notes that the claim limitation "added in the protective layer after the protective layer is formed on the dielectric layer" is drawn to a process of manufacturing which is incidental to the claimed apparatus. It is well established that a claimed apparatus cannot be distinguished over the prior art by a process limitation. Consequently, absent a showing of an unobvious difference between the claimed product and the prior art, the subject product-by-process claim limitation has been considered, but not patentably distinct over Hidaka (see MPEP 2113).

Regarding claim 8, Hidaka discloses in figure 4 and in paragraph 37 a material for a protective layer of a plasma display panel in which a dielectric layer (17) is formed so that the

Art Unit: 2879

dielectric layer (17) covers a scanning electrode (X) and a sustain electrode (Y) formed on a substrate (11), and in which a protective layer (18) is formed on the dielectric layer (17), wherein the material for a protective layer (18) includes carbon and silicon (specifically, [(C₆ H₁₃COO)₄ Si]).

Claim Rejections - 35 USC § 103

The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:

(a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negatived by the manner in which the invention was made.

Claims 2, 5, 6, 9, and 10 are rejected under 35 U.S.C. 103(a) as being unpatentable over Hidaka.

Regarding claim 2, Hidaka discloses in paragraphs 36 and 37 the material for a protective layer is magnesium oxide including carbon and silicon, and the density of silicon is 100ppm.

Hidaka is silent to layer including silicon with $5x10^{18}$ atoms/cm³ to $2x10^{21}$ atoms/cm³, and carbon with $1x10^{18}$ atoms/cm³ to $2x10^{21}$ atoms/cm³.

However, it has been held that where the general conditions of a claim are disclosed in the prior art, discovering the optimum or workable ranges involves only routine skill in the art.

In re Aller, 105 USPQ 233. Further, one would be motivated to use a density of carbon and silicon in the recited range for a variety of reasons, including operation methods requiring sensitive parameters and reduced manufacturing time while maintaining appropriate barrier properties.

Art Unit: 2879

Therefore, in view of the above discussion, it would have been obvious to one having ordinary skill in the art at the time the invention was made to construct Hidaka's PDP with the protection layer having a density of carbon and silicon in the recited range to reduce manufacturing time.

Regarding claims 5 and 9, Hidaka discloses in paragraphs 36 and 37 the material for a protective layer is magnesium oxide including carbon and silicon, and the density of silicon is 100ppm.

While Hidaka is silent to the exact density of carbon, it has been held that where the general conditions of a claim are disclosed in the prior art, discovering the optimum or workable ranges involves only routine skill in the art. *In re Aller*, 105 USPQ 233. Further, one would be motivated to use a density of carbon in a range from 5 to 1500ppm of for a variety of reasons, including operation methods requiring sensitive parameters and reduced manufacturing time while maintaining appropriate barrier properties.

Therefore, in view of the above discussion, it would have been obvious to one having ordinary skill in the art at the time the invention was made to construct Hidaka's PDP with the protection layer having density of carbon from 5 to 1500ppm to reduce manufacturing time.

Regarding claims 6 and 10, Hidaka is silent to the protective layer comprising MgO and SiC in a density of 40 to 12000ppm.

However, the Examiner takes official notice that it is known in the art that SiC is well-known to be resistant to a plasma discharge and can perform as a protection layer.

Art Unit: 2879

-

Furthermore, it has been held that where the general conditions of a claim are disclosed in the prior art, discovering the optimum or workable ranges involves only routine skill in the art.

In re Aller, 105 USPQ 233. One would be motivated to use a density of SiC in a range from 40 to 12000ppm for a variety of reasons, including operation methods requiring sensitive parameters and reduced manufacturing time while maintaining appropriate barrier properties.

Therefore, in view of the above discussion, it would have been obvious to one having ordinary skill in the art at the time the invention was made to construct the protection layer of Hidaka with a density of SiC in a range from 40 to 12000ppm to reduce manufacturing time.

Conclusion

The prior art made of record and not relied upon is considered pertinent to applicant's disclosure. USPN 6171438 to Masuda is evidence that SiC is known to be resistant to a plasma discharge. A computer translation of Hidaka is provided for Applicant's convenience.

Any inquiry concerning this communication or earlier communications from the examiner should be directed to Peter J Macchiarolo whose telephone number is (571) 272-2375. The examiner can normally be reached on 8:30 - 5:00, M-F.

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Nimeshkumar Patel can be reached on (571) 272-2475. The fax phone number for the organization where this application or proceeding is assigned is 703-872-9306.

Information regarding the status of an application may be obtained from the Patent
Application Information Retrieval (PAIR) system. Status information for published applications
may be obtained from either Private PAIR or Public PAIR. Status information for unpublished

Art Unit: 2879

applications is available through Private PAIR only. For more information about the PAIR system, see http://pair-direct.uspto.gov. Should you have questions on access to the Private PAIR system, contact the Electronic Business Center (EBC) at 866-217-9197 (toll-free).

ASHOK PATEL
PRIMARY EXAMINER

•

: